

PRODUCT NUMBER
98423-X61-XXXLF

PLATING _____
S = 0.38µm GOLD/GXT ON CONTACT AREA
2µm MIN MATTE TIN ON TAIL
G = 0.76µm GOLD/GXT ON CONTACT AREA
2µm MIN MATTE TIN ON TAIL
F = GOLD FASH ON CONTACT AREA
2µm MIN MATTE

RoHS COMPATIBLE, SEE NOTE 6

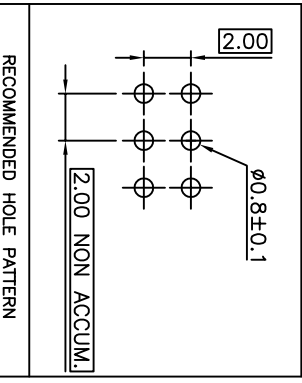
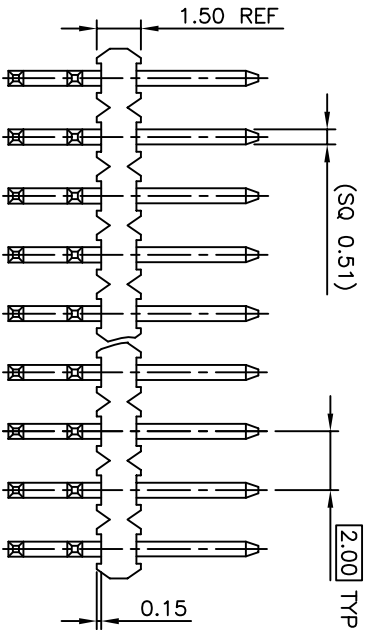
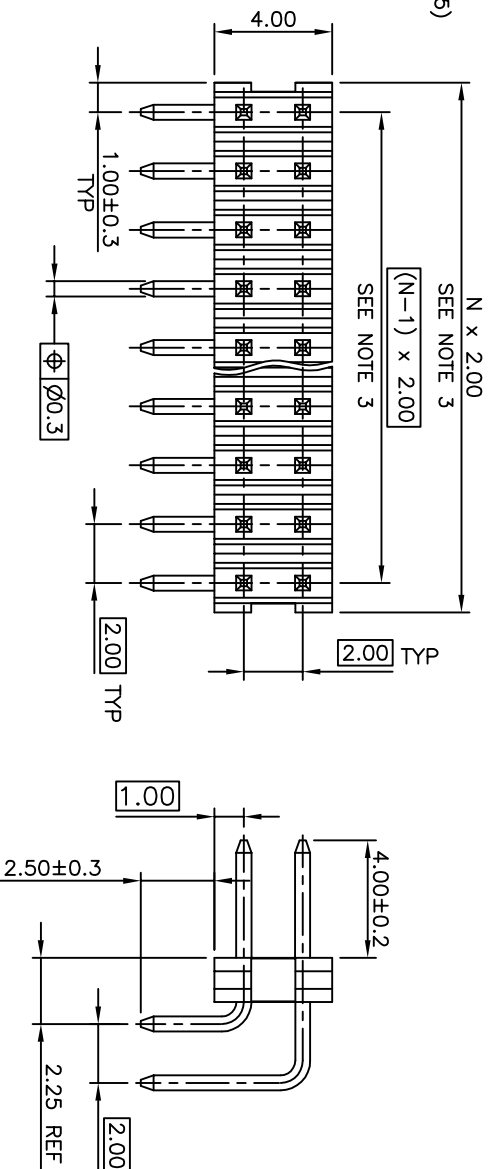
PACKAGING OPTIONAL LETTER (SEE NOTE 5)
NB OF POSITIONS PER ROW
02 TO 25 POS

NOTES:

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC UL 94V-0, COLOR BLACK
2. MATERIAL TERMINAL: COPPER ALLOY
3. TO DETERMINE DIMENSIONS:
N = NUMBER OF POSITIONS PER ROW
4. 7N MIN. PIN RETENTION IN EITHER DIRECTION.
5. PACKAGING:
= PLASTIC BOX
U = TUBE AVAILABLE FROM 06 TO 50 POS

6. RoHS COMPATIBLE PRODUCT SPECIFICATIONS

- a - PLATING:
- "Lf" MEANS THE PRODUCT IS LEAD-FREE, 2µm MINIMUM MATTE TIN OVER 1.27µm MINIMUM NICKEL UNDERPLATE.
- b - MANUFACTURING PROCESS COMPATIBILITY
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
- c - LABELLING:
- MEETS PACKAGING SPECS AS PER GS-14-920
 - THIS PRODUCT MEETS EUROPEAN DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DISCRIBED IN GS-47-0004



mat'l. code		surface		tolerance		projection		product family	
lfr	ecm no	dr	date	ISO 1302	ISO 406	ISO 101	mm	MINITEK	title
A	F10338	LMU	03.10.01	tolerances unless otherwise specified	X ±0.3				UNSHR HEADER
B	F04-0351UC0	05.01.13	angle	linear	X.X ±0.13				RIGHT ANGLE TMT
C	F06-021dLMU	06.07.05			X.XX ±0.05				
D	F08-0145ELA	17.04.08	dr	L MULIN	04.09.28				dwg no
E	B-19190 LMU	14.10.24	eng	JM.C	04.09.28				sheet 1 of 1
			chr						size
			appd						A3
			revision						CUSTOMER Drawing
			index						